



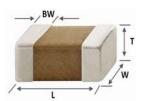
Specification of Automotive MLCC

● Supplier : Samsung electro-mechanics ● Samsung P/N : CL10C511JB81PNC

● AEC-Q200 Qualified

A. Dimension

Dimension



Size	0603 inch
L	1.60±0.10 mm
W	0.80±0.10 mm
Т	0.80±0.10 mm
BW	0.30±0.20 mm

B. Samsung Part Number

<u>CL</u>	<u>10</u>	<u>C</u>	<u>511</u>	<u>J</u>	<u>B</u>	<u>8</u>	<u>1</u>	<u>P</u>	<u>N</u>	<u>C</u>
①	2	3	4	(5)	⑥	⑦	8	9	10	11

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0603 (inch code)	L: 1.60±0.10 mm	W: 0.80±0.10 mm
3 Dielectric	C0G	® Inner electrode	Ni
Capacitance	510 pF	Termination	Cu
⑤ Capacitance	± 5%	Plating	Sn 100% (Pb Free)
tolerance		9 Product	Automotive
Rated Voltage	50 V	Special code	Normal
① Thickness	0.80±0.10 mm	1 Packaging	Cardboard Type, 7" Reel

C. Reliability Test and Judgement condition

	Performance	Test condition		
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature		
Exposure	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion		
	whichever is larger			
	Q: 1,000 min.			
	IR : More than 10,000 № or 500 №× µF			
	Whichever is smaller			
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles		
	Capacitance Change: Within ±2.5% or ±0.25pF	Measurement at 24±2hrs after test conclusion		
	whichever is larger			
	Q: 1,000 min.	1 cycle condition : -55+0/-3°C(30±3min) → Room Temp. (1min)		
	IR : More than 10,000 № or 500 №× μF	\rightarrow 125+3/-0 $^{\circ}$ C(30±3min) \rightarrow Room Temp. (1min)		
	Whichever is smaller			
Destructive Physical	No Defects or abnormalities	Per EIA 469		
Analysis				
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85 ℃/85%RH, Rated Voltage and 1.3~1.5V,		
	Capacitance Change: Within ±2.5% or ±0.25pF	Add 100kohm resistor		
	whichever is larger			
	Q: 200 min.	The charge/discharge current is less than 50mA.		
	IR : More than 500 MΩ or 25 MΩ×μF			
	Whichever is smaller			
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125 ℃, 200% Rated Voltage,		
Operating Life	Capacitance Change: Within ±3% or ±0.3pF	Measurement at 24±2hrs after test conclusion		
	whichever is larger	The charge/discharge current is less than 50mA.		
	Q: 350 min.			
	IR : More than 1,000 № or 50 № × μF			
	Whichever is smaller			

	Performance	Test condition			
External Visual	No abnormal exterior appearance	Microscope ('10)			
Physical Dimensions	Within the specified dimensions	Using The calipers			
Mechanical Shock	Appearance: No abnormal exterior appearance Capacitance Change: Within ±2.5% or ±0.25pF whichever is larger Q, IR: Initial spec.	Three shocks in each direction should be applied along 3 mutually perpendicular axes of the test specimen (18 shocks) Peak value Duration Wave Velocity 1,500G 0.5ms Half sine 4.7m/sec			
Vibration	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger Q, IR : Initial spec.	5g's for 20min., 12cycles each of 3 orientations, Use 8"×5" PCB 0.031" Thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10~2,000Hz.			
Resistance to Solder Heat	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger Q, IR : Initial spec.	Preheating : 150°C for 60~120 sec. Solder pot : 260±5°C, 10±1sec.			
ESD	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger Q, IR : Initial spec.	AEC-Q200-002 or ISO/DIS10605			
Solderability	95% of the terminations is to be soldered evenly and continuously	a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5°C b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5°C c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5°C solder: a solution ethanol and rosin			
Electrical Characterization	Capacitance: Within specified tolerance Q: 1,000 min. IR(25℃): More than 100,000 № or 1,000 №×μF Whichever is smaller. IR(125℃): More than 10,000 № or 100 №×μF Whichever is smaller.	The Capacitance / D.F. should be measured at 25 °C, 1 № ± 10%, 0.5~5 Vrms I.R. should be measured with a DC voltage not exceeding Rated Voltage @25 °C, @125 °C for 60~120 sec.			
Board Flex	Dielectric Strength Appearance : No abnormal exterior appearance Capacitance Change : Within ±5% or ±0.5pF whichever is larger	Dielectric Strength : 300% of the rated voltage for 1~5 seconds Bending to the limit, 3 mm for 60 seconds			
Terminal Strength(SMD)	Appearance : No abnormal exterior appearance Capacitance Change : Within ±2.5% or ±0.25pF whichever is larger	10 N, for 60 sec.			
Beam Load Temperature Characteristics	Destruction value should be exceed 20 N C0G From -55 $^{\circ}$ C to 125 $^{\circ}$ C, Capacitance change should	Beam speed : 0.5±0.05 mm/sec be within 0±30ppm/℃			

D. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260 +0/-5 $^{\circ}$ C, 30sec.), Meet IPC/JEDEC J-STD-020 D Standard



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

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- ② Medical equipment
- 3 Military equipment
- 4 Disaster prevention/crime prevention equipment
- ⑤ Power plant control equipment
- 6 Atomic energy-related equipment
- ① Undersea equipment
- 8 Traffic signal equipment
- Data-processing equipment
- @ Electric heating apparatus, burning equipment
- Safety equipment
- @ Any other applications with the same as or similar complexity or reliability to the applications